

### Typical Applications

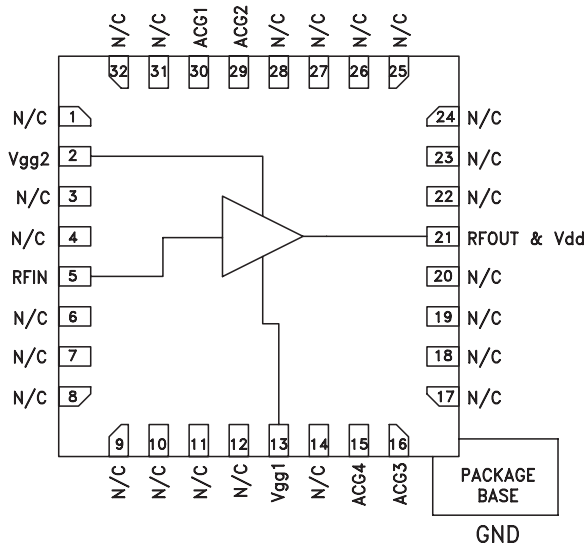
The HMC465LP5(E) wideband driver is ideal for:

- OC192 LN/MZ Modulator Driver
- Microwave Radio & VSAT
- Test Instrumentation
- Military EW, ECM & C<sup>3</sup>I

### Features

- Gain: 15 dB
- Output Voltage to 10Vpk-pk
- +24 dBm Saturated Output Power
- Supply Voltage: +8V @160 mA
- 50 Ohm Matched Input/Output
- 32 Lead 5x5 mm QFN Package: 25 mm<sup>2</sup>

### Functional Diagram



### General Description

The HMC465LP5(E) is a GaAs MMIC PHEMT Distributed Driver Amplifier packaged in leadless 5x5 mm surface mount package which operate between DC and 20 GHz. The amplifier provides 15 dB of gain, 3 dB noise figure and +25 dBm of saturated output power while requiring only 160 mA from a +8V supply. Gain flatness is excellent at ±0.5 dB as well as ±4 deg deviation from linear phase from DC - 10 GHz making the HMC465LP5(E) ideal for OC192 fiber optic LN/MZ modulator driver amplifiers as well as test equipment applications. The HMC465LP5(E) amplifiers I/Os are internally matched to 50 Ohms.

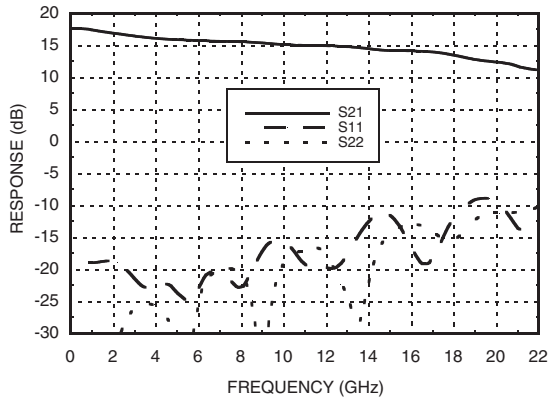
### Electrical Specifications, $T_A = +25^\circ C$ , $V_{dd} = 8V$ , $V_{gg2} = 1.5V$ , $I_{dd} = 160 mA^*$

Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range	DC - 6			6.0 - 12.0			12.0 - 20.0			GHz
Gain	13	16		12	15		9.5	12.5		dB
Gain Flatness		±0.75			±0.25			±1.5		dB
Gain Variation Over Temperature		0.015	0.02		0.020	0.025		0.035	0.045	dB/ °C
Noise Figure		3.0			3.0			4.0		dB
Input Return Loss		20			15			8		dB
Output Return Loss		22			17			12		dB
Output Power for 1 dB Compression (P1dB)	21	24		20	23		16	20		dBm
Saturated Output Power (Psat)		25.5			25			23		dBm
Output Third Order Intercept (IP3)		32			28			24		dBm
Saturated Output Voltage		10			10			8		Vpk-pk
Group Delay Variation		±15			±15					pSec
Supply Current (Idd) (Vdd= 8V, Vgg1= -0.6V Typ.)		160			160			160		mA

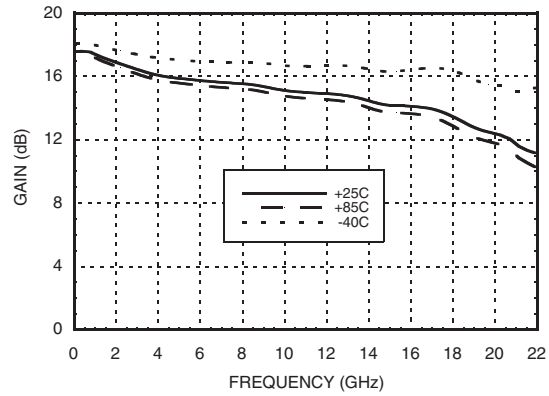
\* Adjust Vgg1 between -2 to 0V to achieve Idd= 160 mA typical.



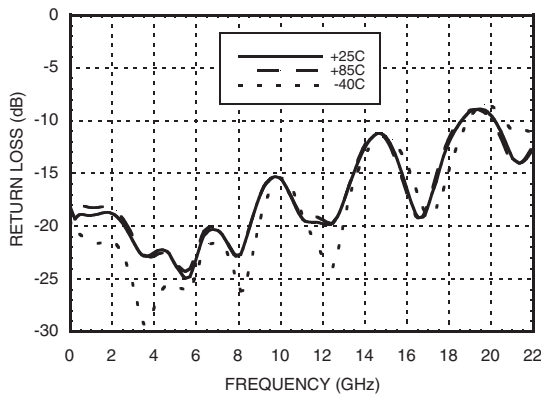
**Gain & Return Loss**



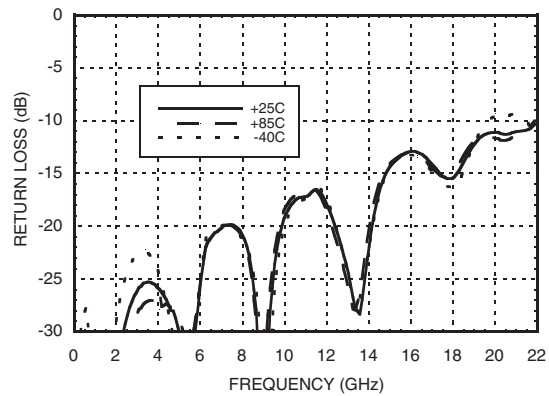
**Gain vs. Temperature**



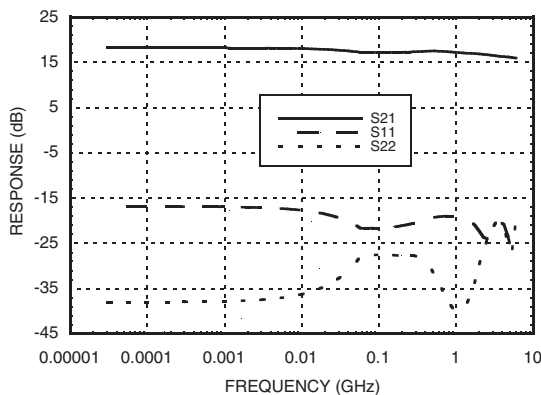
**Input Return Loss vs. Temperature**



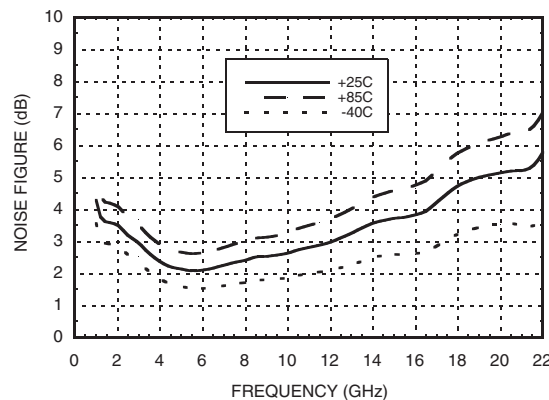
**Output Return Loss vs. Temperature**



**Low Frequency Gain & Return Loss**

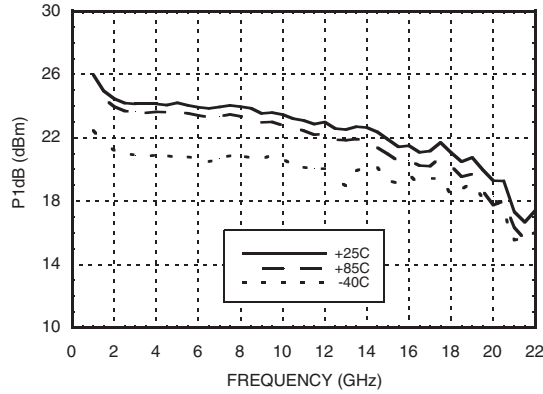


**Noise Figure vs. Temperature**

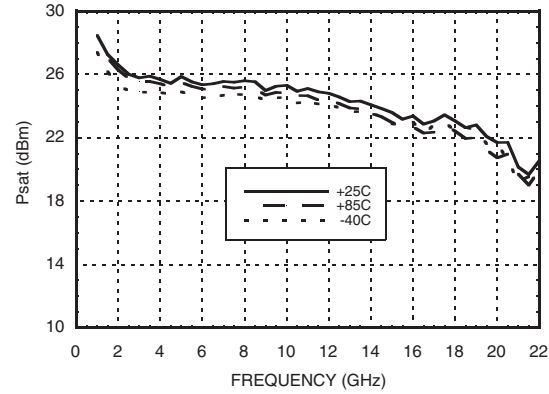




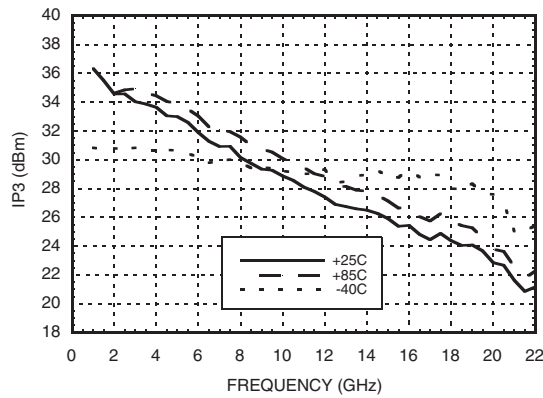
**P1dB vs. Temperature**



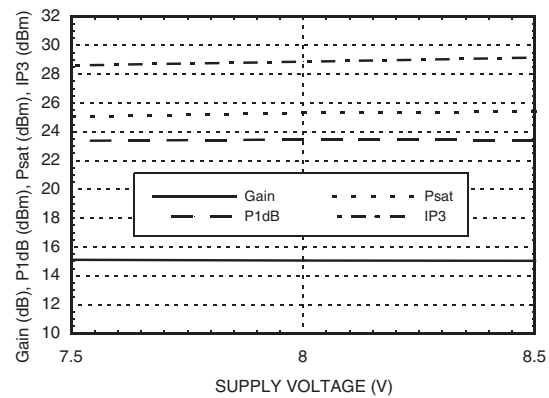
**Psat vs. Temperature**



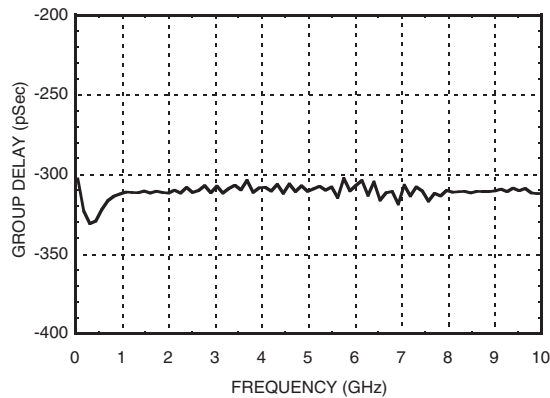
**Output IP3 vs. Temperature**



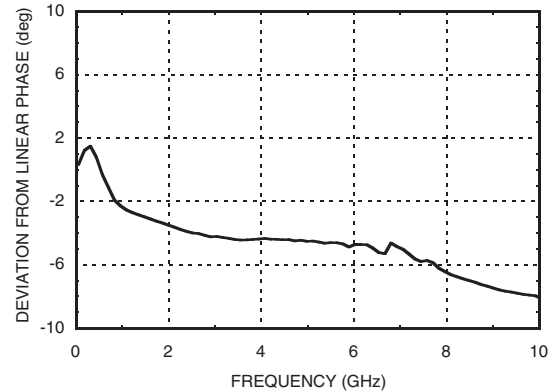
**Gain, Power & Output IP3 vs. Supply Voltage @ 10 GHz, I<sub>dd</sub> = 160mA**



**Group Delay**



**Deviation from Linear Phase**





### Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+9 Vdc
Gate Bias Voltage (Vgg1)	-2 to 0 Vdc
Gate Bias Current (Igg1)	+3.2mA
Gate Bias Voltage (Vgg2)	(Vdd -8) Vdc to +3 Vdc
Gate Bias Current (Igg2)	+3.2mA
RF Input Power (RFIN)(Vdd = +8 Vdc)	+23 dBm
Channel Temperature	150 °C
Continuous P <sub>diss</sub> (T = 85 °C) (derate 24 mW/°C above 85 °C)	1.56 W
Thermal Resistance (channel to ground paddle)	41.5 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

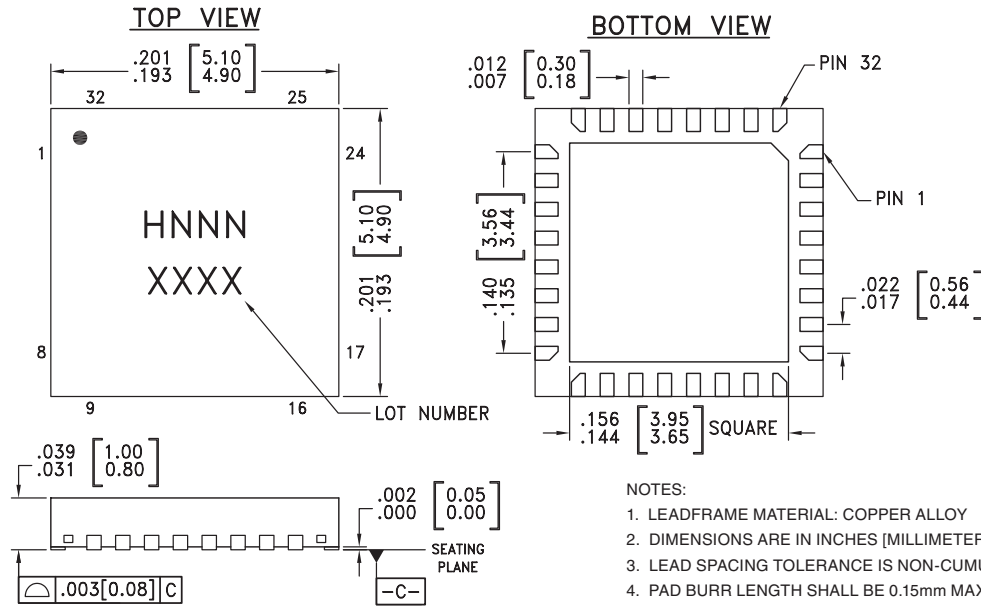
### Typical Supply Current vs. Vdd

Vdd (V)	I <sub>dd</sub> (mA)
+7.5	161
+8.0	160
+8.5	159



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

### Outline Drawing



#### NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.  
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC465LP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 <sup>[1]</sup>	H465 XXXX
HMC465LP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	H465 XXXX

[1] Max peak reflow temperature of 235 °C

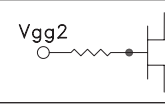


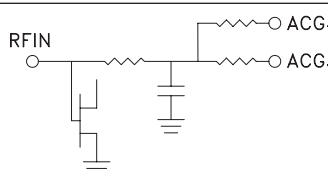
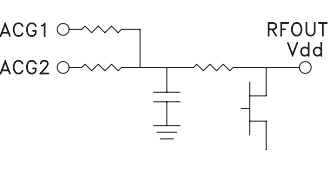

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

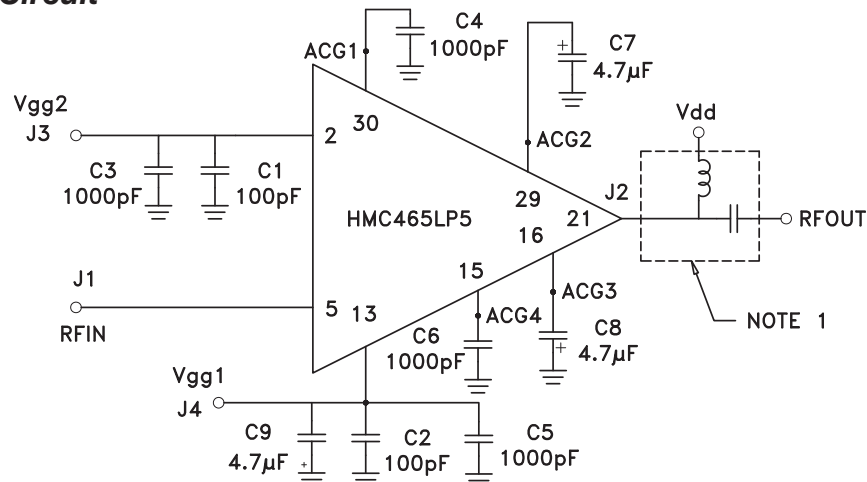


## GaAs PHEMT MMIC MODULATOR DRIVER AMPLIFIER, DC - 20 GHz

### Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 4, 6 - 12, 14, 17, 18, 19, 20, 22 - 28, 31, 32	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
2	Vgg2	Gate Control 2 for amplifier. +1.5V should be applied to Vgg2 for nominal operation.	
5	RFIN	This pad is DC coupled and matched to 50 Ohms.	
13	Vgg1	Gate Control 1 for amplifier.	
15	ACG4	Low frequency termination. Attach bypass capacitor per application circuit herein.	
16	ACG3		
21	RFOUT & Vdd	RF output for amplifier. Connect the DC bias (Vdd) network to provide drain current (Idd). See application circuit herein.	
29	ACG2	Low frequency termination. Attach bypass capacitor per application circuit herein.	
30	ACG1		
Ground Paddle	GND	Ground paddle must be connected to RF/DC ground.	

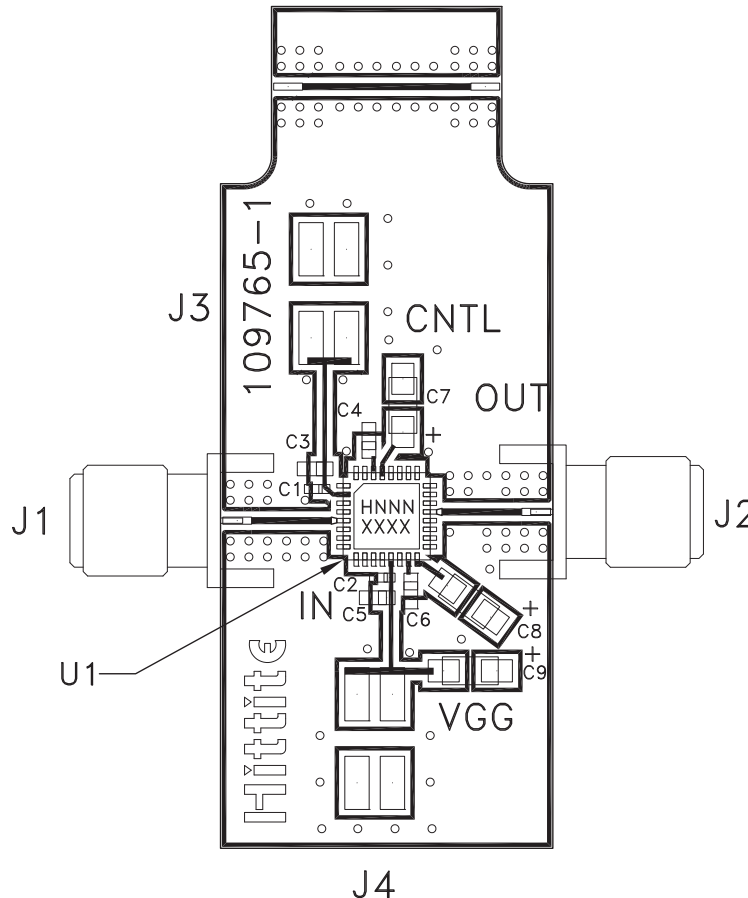
### Application Circuit



NOTE 1: Drain Bias (Vdd) must be applied through a broadband bias tee or external bias network.



### Evaluation PCB



### List of Materials for Evaluation PCB 108347 [1]

Item	Description
J1 - J2	SRI K Connector
J3 - J4	2mm Molex Header
C1, C2	100 pF Capacitor, 0402 Pkg.
C3 - C6	1000 pF Capacitor, 0603 Pkg.
C7 - C9	4.7 $\mu$ F Capacitor, Tantalum
U1	HMC465LP5 / HMC465LP5E
PCB [2]	109765 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.



**GaAs PHEMT MMIC MODULATOR DRIVER  
AMPLIFIER, DC - 20 GHz**

**Device Operation**

These devices are susceptible to damage from Electrostatic Discharge. Proper precautions should be observed during handling, assembly and test.

The input to this device should be AC-coupled. To provide the typical 8Vp-p output voltage swing, a 1.2Vp-p AC-coupled input voltage swing is required.

**Device Power Up Instructions**

1. Ground the device
  2. Set V<sub>gg</sub> to -2V (no drain current)
  3. Set V<sub>ctl</sub> to +1V (no drain current)
  4. Set V<sub>dd</sub> to +5V (no drain current)
  5. Adjust V<sub>gg</sub> for I<sub>dd</sub> = 140mA
- V<sub>gg</sub> may be varied between -1V and 0V to provide the desired eye crossing point percentage (i.e. 50% crosspoint) and a limited cross point control capability.
  - V<sub>dd</sub> may be increased to +7V if required to achieve greater output voltage swing.
  - V<sub>ctl</sub> may be adjusted between +2V and +0V to vary the output voltage swing.

**Device Power Down Instructions**

1. Reverse the sequence identified above in steps 1 through 4.



**Notes:**



Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «**JONHON**», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «**FORSTAR**».



## JONHON

«**JONHON**» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«**FORSTAR**» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: [ocean@oceanchips.ru](mailto:ocean@oceanchips.ru)

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А